	Application No.	Applicant(s)	10-
Notice of Allowability	09/987,409	SAKURAI, KAZUNORI	
	Examiner	Art Unit	-
	Lisa Kilday	2829	
The MAILING DATE of this communication a All claims being allowable, PROSECUTION ON THE MERITS herewith (or previously mailed), a Notice of Allowance (PTOL- NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATEN of the Office or upon petition by the applicant. See 37 CFR 1.	S IS (OR REMAINS) CLOSED in -85) or other appropriate commu T RIGHTS. This application is s	n this application. If not included unication will be mailed in due course	
1. X This communication is responsive to after-fianl amende	<u>ment of 8/18/4</u> .		
2. X The allowed claim(s) is/are 2,3,5,8 and 19-21.			
3. $igotimes$ The drawings filed on <u>14 November 2001</u> are accepted	by the Examiner.		
 4. ☐ Acknowledgment is made of a claim for foreign priorit a) ☐ All b) ☐ Some* c) ☐ None of the: 1. ☐ Certified copies of the priority documents h 		or (f).	
2. Certified copies of the priority documents h		on No	
3. Copies of the certified copies of the priority	documents have been received	d in this national stage application fro	om the
International Bureau (PCT Rule 17.2(a)).			
* Certified copies not received:	1887 - J		
Applicant has THREE MONTHS FROM THE "MAILING DA' noted below. Failure to timely comply will result in ABANDO THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.		a reply complying with the requirem	ents
 A SUBSTITUTE OATH OR DECLARATION must be su INFORMAL PATENT APPLICATION (PTO-152) which 			E OF
6. CORRECTED DRAWINGS (as "replacement sheets")	must be submitted.		
(a) ☐ including changes required by the Notice of Drafts	person's Patent Drawing Review	w (PTO-948) attached	
1) 🗌 hereto or 2) 🗍 to Paper No./Mail Date			
(b) ☐ including changes required by the attached Examine Paper No./Mail Date	ner's Amendment / Comment or	r in the Office action of	
Identifying indicia such as the application number (see 37 CF each sheet. Replacement sheet(s) should be labeled as such	FR 1.84(c)) should be written on the in the header according to 37 CF	he drawings in the front (not the back) R 1.121(d).	of
 DEPOSIT OF and/or INFORMATION about the do attached Examiner's comment regarding REQUIREME 			ne
Attachment(s)	E □ Nation of In	formal Detant Application (DTO 150)	
1. Notice of References Cited (PTO-892)		formal Patent Application (PTO-152))
 Notice of Draftperson's Patent Drawing Review (PTO-9⁴ 	Paper No./	ummary (PTO-413), Mail Date	
	\$B/08\ 7 □ Evaminer's	Amendment/Comment	
	35/00), 7. <u>Cammer 3</u>		
Information Disclosure Statements (PTO-1449 or PTO/S Paper No./Mail Date Examiner's Comment Regarding Requirement for Deport	,, –	Statement of Reasons for Allowance	e

Allowable Subject Matter

Claims 2-3, 5, 8 and 19-21 allowed.

The following is an examiner's statement of reasons for allowance: amendment to independent claim 19 necessitates allowance of claims 2-3, 5, 8 and 19-21. In reclaims 2-3, 5, 8 and 19-21, Tsukahara teaches a method of manufacturing a semiconductor device including a step of mounting a semiconductor chip on a wiring substrate having a base substrate (see fig. 14c where the base substrate 21 is pad of the wiring substrate which comprises references 4 + 21) on which are formed interconnecting lines (see ref. 33 in fig, 14b where ref. 33 is part of the interconnecting lines found on the wiring substrate), the method comprising: mounting the semiconductor chip (1) on the base substrate (the area on top near the chip) to that a surface of the base substrate opposite to the surface on which the interconnecting lines (the lines are formed on the bottom of ref. 21 at the interface with ref. 4) are formed with bumps (see ref. 15 in fig. 14b where the bumps are down and touch the contact surface and in fig. 14c where he bumps penetrate the substrate and contact is with the base substrate) formed on the semiconductor chip (1). Prior art fails to teach or suggest the limitation of: pushing the bumps into the base substrate from the first surface through the base substrate to a second surface opposite to the first surface and then electrically connecting the bumps to interconnecting lines formed on the second surface of the base substrate.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably Application/Control Number: 09/987,409 Page 3

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accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Conclusion

Any inquiry of a general nature or relating to the status of this application should be directed to the Group Receptionist whose telephone number is (703) 308-0957. See MPEP 203.08.

Any inquiry concerning this communication from the examiner should be directed to Lisa Kilday whose telephone number is (571) 272-1962. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Tokar, can be reached on (571) 272-1812. The fax number for the group is (703) 872-9306. MPEP 502.01 contains instructions regarding procedures used in submitting responses by facsimile transmission.

Lisa Kilday

LAK (A

9/2/04

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